



DSS5160TQ

60V LOW V_{CE(SAT)} PNP SURFACE MOUNT TRANSISTOR

Description

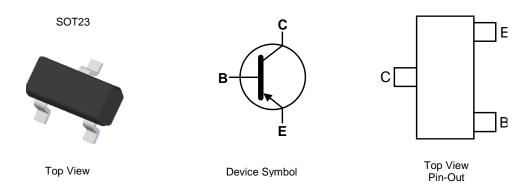
This Bipolar Junction Transistor (BJT) is designed to meet the stringent requirements of Automotive Applications.

Features

- BV_{CEO} > -60V
- I_C = -1A Continuous Collector Current
- I_{CM} = -2A Peak Pulse Current
- Epitaxial Planar Die Construction
- Ideal for Medium Power Amplification and Switching
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight 0.008 grams (Approximate)



Ordering Information (Notes 4 and 5)

Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DSS5160TQ-7	Automotive	ZP9	7	8mm	3,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

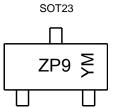
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



ZP9 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: E = 2017) M or \overline{M} = Month (ex: 9 = September)

Date Code Key												
Year	2017	2	018	2019	2	2020	2021		2022	2023		2024
Code	E		F	G		Н	I		J	K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-80	V
Collector-Emitter Voltage	V _{CEO}	-60	V
Emitter-Base Voltage	V _{EBO}	-5	V
Continuous Collector Current	lc	-1	A
Peak Pulse Collector Current	I _{CM}	-2	A
Base Current (DC)	IB	-300	mA
Peak Base Current	I _{BM}	-1	А

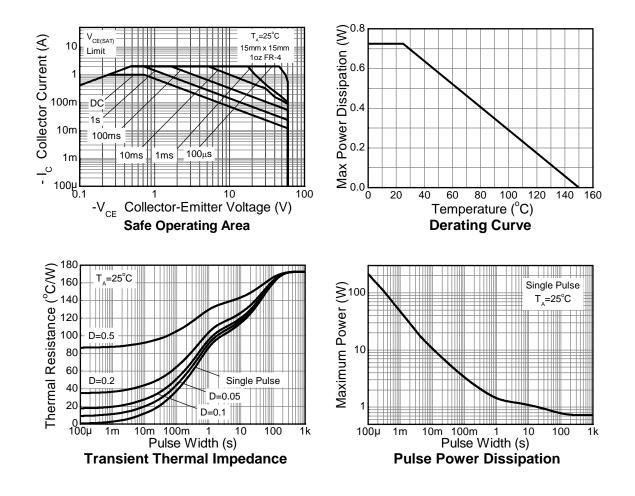
Thermal Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	725	mW
Thermal Resistance, Junction to Ambient (Note 7)	R _{0JA}	172	°C/W
Thermal Resistance, Junction to Ambient Air (Note 6)	R _{0JA}	79	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes: 6. Operated under pulsed conditions: pulse width ≤ 100 ms, duty cycle ≤ 0.25 .

7. Device mounted on 15mm x 15mm x1.6mm FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions.

Thermal Characteristics





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Collector-Base Breakdown Voltage	BV _{CBO}	-80	1.76	Max	V	$I_{\rm C} = -100\mu A$
Collector-Emitter Breakdown Voltage (Note 8)	BVCBO	-60			V	$I_c = -100\mu A$
Emitter-Base Breakdown Voltage		-00			V	$I_E = -100\mu A$
	BV _{EBO}	-		-100	nA	
Collector-Base Cutoff Current	Iсво	_				$V_{CB} = -20V, I_E = 0$
				-50	μA	$V_{CB} = -20V, I_E = 0, T_A = +150^{\circ}C$
Emitter-Base Cutoff Current	I _{EBO}			-100	nA	$V_{EB} = -5V, I_{C} = 0$
		200	—	—	-	$V_{CE} = -5V, I_{C} = -1mA$
DC Current Gain (Note 6)	h _{FE}	150			—	$V_{CE} = -5V, I_C = -500mA$
		100	_	_		$V_{CE} = -5V, I_{C} = -1A$
		_	_	-175		I _C = -100mA, I _B = -1mA
Collector-Emitter Saturation Voltage (Note 8)	V _{CE(SAT)}	_	_	-180		I _C = -500mA, I _B = -50mA
	52(0,11)	_	_	-340		I _C = -1A, I _B = -100mA
Equivalent On-Resistance	R _{CE(SAT)}	_	_	340	mΩ	I _E = -1A, I _B = -100mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	_	-1.1	V	I _C = -1A, I _B = -50mA
Base-Emitter Turn-On Voltage	V _{BE(ON)}	_	_	-0.9	V	$V_{CE} = -5V, I_{C} = -1A$
Transition Frequency	f⊤	150	—	—	MHz	$V_{CE} = -10V, I_{C} = -50mA,$ f = 100MHz
Output Capacitance	COB	_	_	15	pF	$V_{CB} = -10V, f = 1MHz$
Turn-On Time	t _{ON}	—	75		ns	
Delay Time	tD	_	35	_	ns	
Rise Time	t _R	_	40	—	ns	$V_{CC} = -10V, I_{C} = -0.5A,$
Turn-Off Time	t _{OFF}		265		ns	$I_{B1} = I_{B2} = -25mA$
Storage Time	t _S		230		ns]
Fall Time	t _F	_	35	_	ns	

Note: 8. Measured under pulsed conditions. Pulse width = 300μ s. Duty cycle $\leq 2\%$.



T_A = 150°C

-55°C

100

1,000

= 85°C TΔ

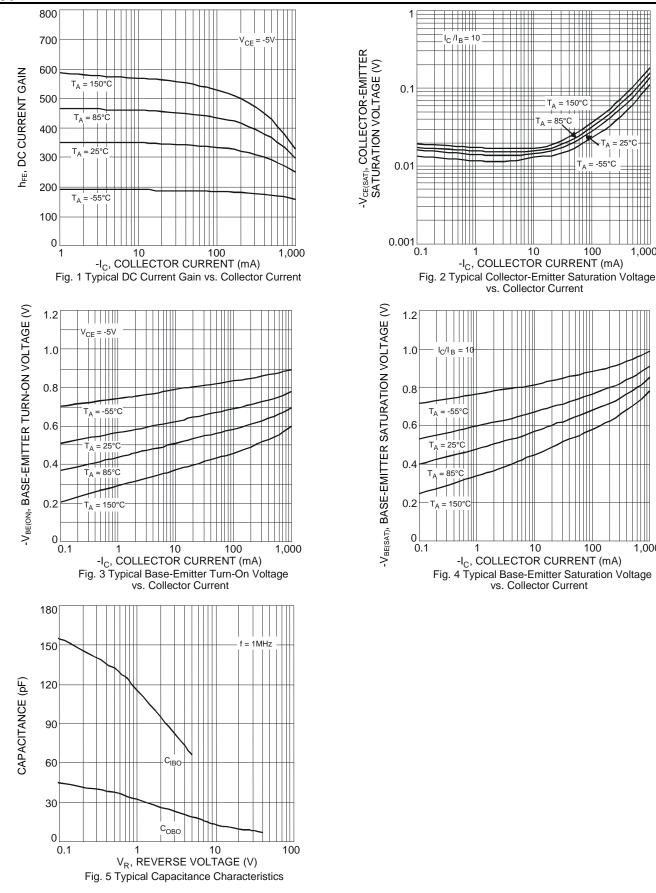
10

10

100

1,000

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)



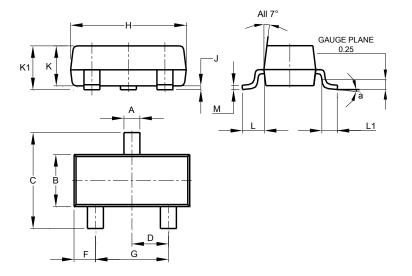
DSS5160TQ Document number: DS39400 Rev. 2 - 2 Downloaded from Arrow.com.



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

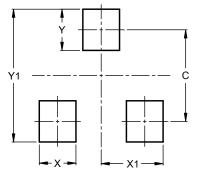


	SOT23						
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All	Dimens	ions in	mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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